



# Power future microgrids with ST digital ESS

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Power & Energy Competence Center, Asia-Pacific

### Agenda

- 1 Carbon neutrality & microgrids
- 2 ST digital power ESS solution
- 3 Key products
- 4 Summary





# **Carbon neutrality & microgrids**



## Innovations contributing to carbon neutrality

### **Green energy generation**



Electric power sector accounts for 40% of global carbon emissions

# Fast DC charging For e-mobility



Transportation sector accounts for 23% of global carbon emissions

# High efficiency for telecom & datacenters



Communications sector accounts for ~4% of global carbon emissions (14% by 2040)



## Challenges for the grid

How to optimize investment in **energy transmission** upgrades?





How to manage **peak loads** as they become increasingly **unpredictable**?

How to set up **new grid infrastructure** in congested areas?

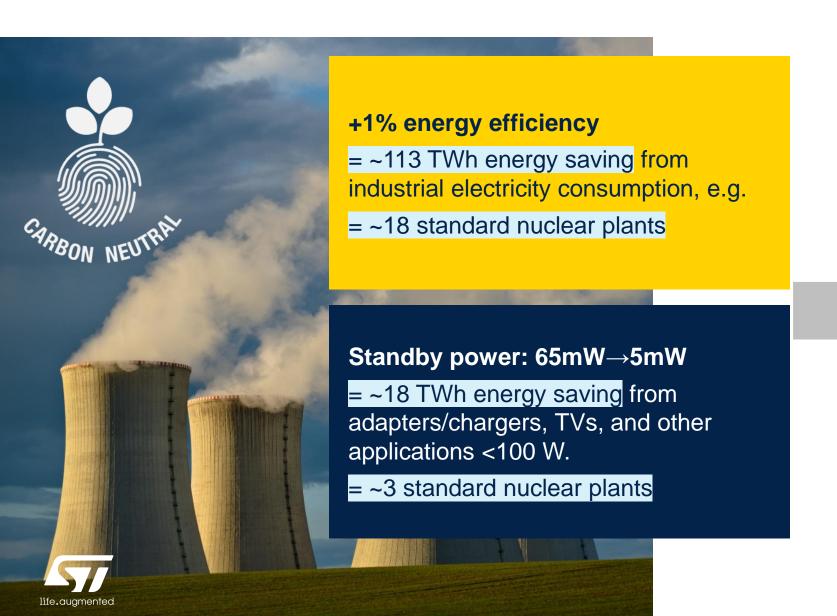




How to ensure a reliable supply to critical functions?



### New semiconductor trends and opportunities

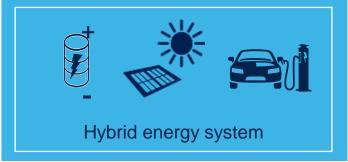


### SiC, GaN & SiP

Superior switching performance results in higher efficiency and lower system cost (higher density)

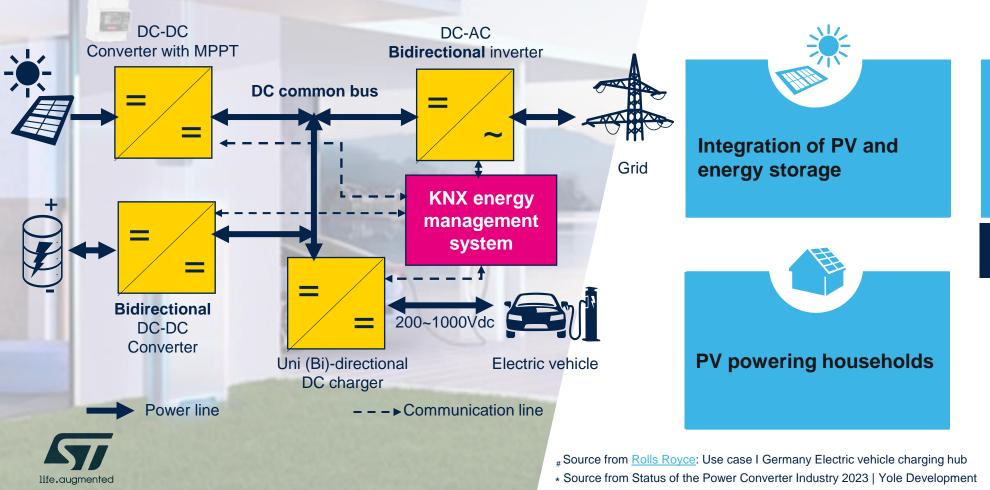






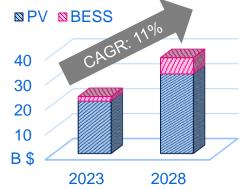
# Electricity 4.0: enabling hybrid energy systems

### Increase grid independence, lowering energy costs by up to 11%#





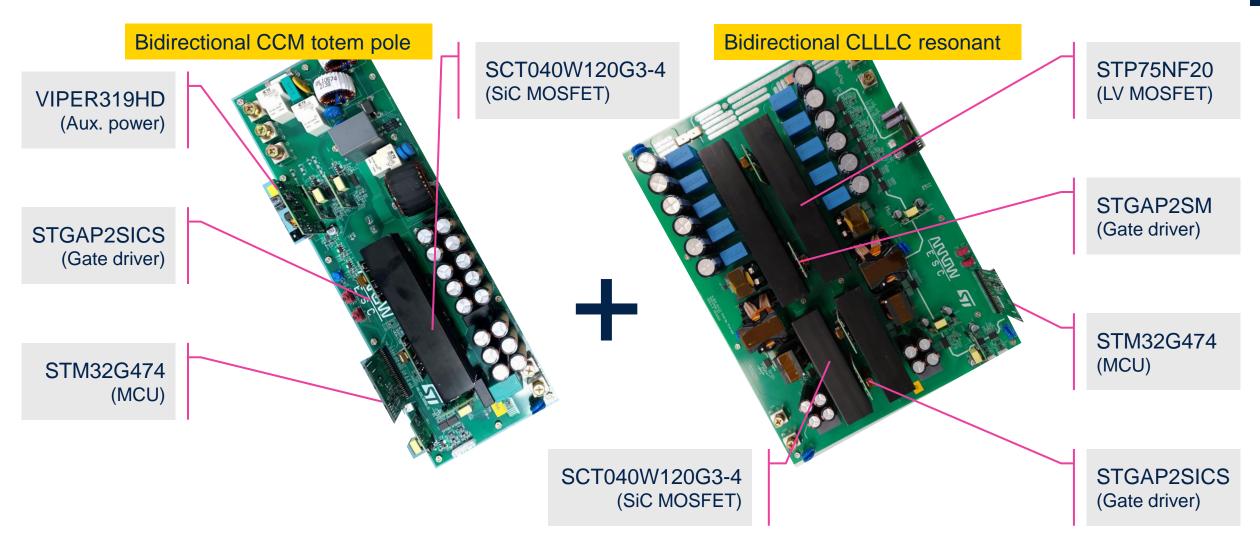
Power converter market split by application \*



# ST digital power ESS solution



### 6.6 kW bidirectional AC-DC







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### 6.6 kW bidirectional PFC

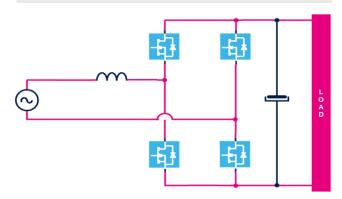








#### **Totem pole PFC**



### Key features:

- Grid voltage: 180-265 VAC
- DC bus voltage: 380-580 VDC
- Switching frequency: 100 kHz
- Operation mode: CCM
- Peak efficiency: 98.5% @230 VAC
- 6.6 kW power delivery in both of AC-DC/DC-AC operations including below modes:
  - ✓ AC to DC operation as rectifier mode
  - ✓ DC to AC operation as off-grid (UPS) mode
  - ✓ DC to AC operation as grid-connection mode



### **Key products**

STM32G474VBT MCU SCT040W120G3-4AG SiC MOSFET STGAP2SICS, VIPER319HD TSZ181ILT, TS3022IDT, A6986, TL431ACL3T, LD1117SC-R

### **Key benefits**

- Compatible with photovoltaic systems (regulated output voltage from 380 to 580 Vdc)
- ✓ SiC and full digital solution to achieve higher efficiency and higher power density



## PFC digital platform - STM32G474

Arm® Cortex® -M4 up to **170MHz** 



### Configurations of MCU key functions on digital PFC

# Floating-point unit (**FPU**)

 Control loop computation (reserved for future use)

#### 32-Kbyte **CCM-SRAM**

Zero wait-state for critical code execution

# **CORDIC** for trigonometric functions acceleration

Software phase-locked loop (EPLL)

### Hi-Resolution PWM Timer (184 ps)

Mainly for high frequency (HF) MOSFET control at 100kHz

# Multiple ADCs (4 Msps) up to 5

 Grid voltage, inductor current, DC bus voltage/current and hotspot

# Comparators and DACs up to 7

PFC OVP / OCP

# FMAC filter mathematical accelerator

1111111111111

57

STM32G4

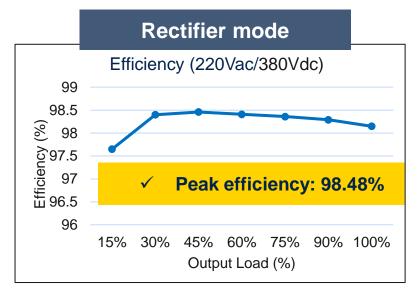
 Hardware digital filter (CPU off-load) for loop computation (reserved)

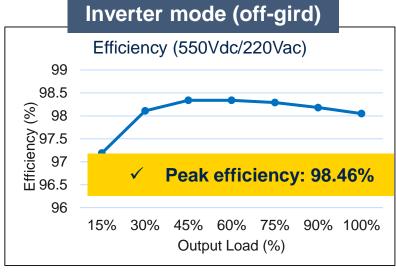
# uart, spi, can and usb

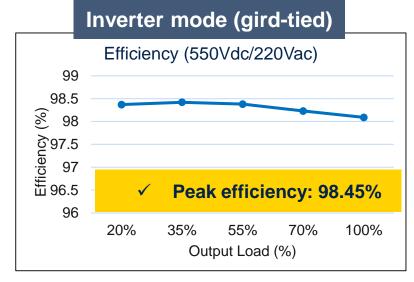
CAN for internal/external communication

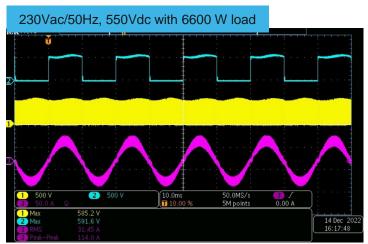


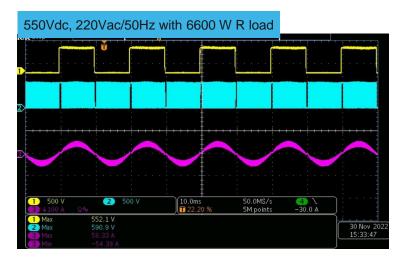
### Experimental results

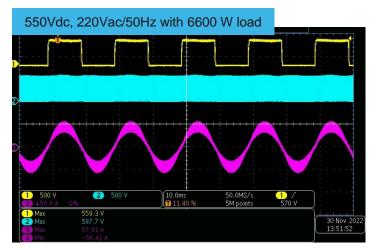












- CH1 (yellow): Vds of upper high-speed MOSFET
- CH2 (blue): Vds of upper low-speed MOSFET
- CH3 (purple): Inductor current

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- CH2 (blue): Vds of upper high-speed MOSFET
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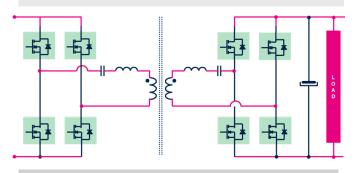


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### 6.6 kW bidirectional DC-DC

#### Interleaved CLLLC



x2 (2-phase)
(Both primary/secondary are in parallel)











### Key features:

- Battery voltage: 60-90 VDC
- DC bus voltage: 380-580 VDC
- Resonant frequency: 200k Hz (160-300 kHz)
- Peak efficiency: >96%

- 6.6 kW power delivery in bidirectional operations, including the following modes:
  - ✓ High voltage to low voltage charging
  - ✓ Low voltage to high voltage discharging

### **Key products**

STM32G474VBT MCU SCT040W120G3-4AG, STP75NF20 power MOSFETs STGAP2SICS (DCDC-Hi), STGAP2SM (DCDC-Lo), VIPER319HD TSZ181ILT, TS3022IDT, A6986, TL431ACL3T, LD1117SC-R

### **Key benefits**

- Compatible with photovoltaic systems (regulated output voltage from 380 to 580 Vdc)
- ✓ SiC and full digital solution to achieve higher efficiency and higher power density



## DC-DC digital platform - STM32G474

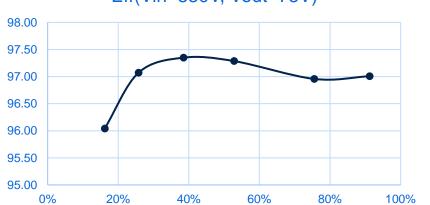
Arm® Cortex® -M4 up Configurations of key MCU functions on digital DC-DC to **170MHz Hi-Resolution PWM** Floating-point Unit **Timer** (184 ps) (FPU) Mainly for high frequency MOSFET control at 150kHz~400kHz Control loop computation Multiple ADCs (4 Msps) 57 up to 5 32-Kbyte **CCM-SRAM** STM32G4 DC voltage/current, tank current, and hotspot Zero wait-state for critical code execution **Comparators** and **DACs CORDIC** for trigonometric up to 7 functions acceleration Tank current OCP Hardware trigonometric calculation **FMAC** filter mathematical (reserved) **UART, SPI, CAN** accelerator and USB Hardware digital filter (CPU off-load) CAN for internal/external for loop computation (reserved) communication



## Experimental results

#### **Charging mode**

#### Eff(Vin=550V, Vout=75V)

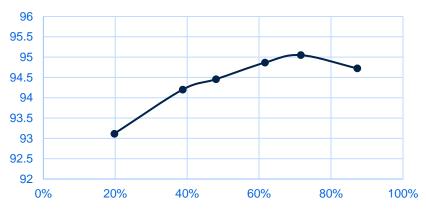


#### Vin=550 V, lout=40 A, steady state



#### **Discharging mode**

#### Eff(Vin=75V, Vout=520V)



#### Vin=70.5Vdc, Iout=4.2 A, steady state





CH1:	HV mos, Vgs, LLC1	CH3:	iTank, LLC1
CH2:	HV mos, Vds, LLC2	CH4:	LV mos, Vds, LLC1
CH5	LV mos, Vds, LLC2	CH6:	iTank, LLC2

# **Key products**





### STPOWER SiC MOSFET families

### The best switching devices for high density applications

Gen1

1200-1700 V

Gen2

650, 1200 V

Gen3

650, 750, 900, 1200 V

Excellent **Ron vs. Tj** behavior: very suitable for SMPS and medium power motor drives

Optimized @ **Vgs 20 V** 

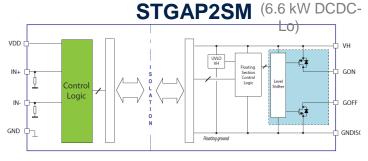
Outstanding Ron vs. Qg trade-off: highly suitable for a broad range of automotive and industrial applications
Optimized @ Vgs 18 V

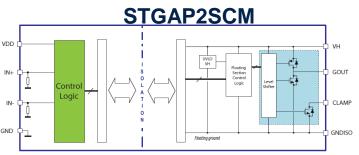
The best Ron vs. Qg trade off: highly suitable for very high frequency applications industrial & automotive Optimized @ Vgs 18 V, enables 15 V gate drive also



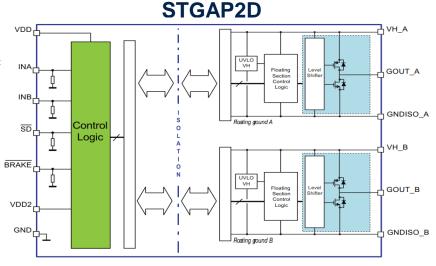
# STGAP gate driver

### 1700 V, 6 kV galvanic isolated single & dual channel





- 3V3/5 V logic inputs
- Up to 26 V supply voltage
- 4 A sink/source driver current capability
- 100 V / ns CMTI
- Propagation delay 80 ns
- Standby function
- High-voltage rail up to 1700 V
- Temperature shut down protection

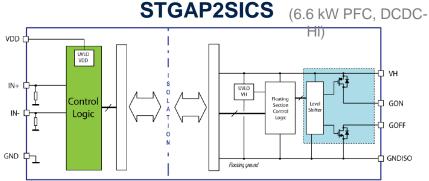


#### **High performance**

Galvanic isolated up to 1700V

#### **Robustness**

- Interlocking
- Negative gate drive ability



#### **High performance**

 Galvanic isolated up to 6 kV optimized for SiC MOSFETs



### STM32G474 MCU

# Hi-resolution PWM and comprehensive set of analog peripherals for digital control

#### Connectivity

4x SPI, 4x I2C, 6x UxART

1x USB 2.0 FS, 1x USB-C PD3.0 (+PHY)

Arm® Cortex®-M4

Up to 170 MHz

213 DMIPS

Floating Point Unit

Memory Protection Unit

**Embedded Trace** 

Macrocell

6-channel DMA + MUX

Up to 2x 256-Kbyte Flash memory / ECC

**Dual Bank** 

96-Kbyte SRAM

3x CAN-FD

2x I2S half duplex, SAI

#### **External interface**

FSMC 8-/16-bit (TFT-LCD, SRAM, NOR, NAND)

Quad SPI

#### **Accelerators**

ART Accelerator™

32-Kbyte CCM-SRAM

**Math Accelerators** 

Cordic (trigo...) Filtering

#### Timers

5x 16-bit timers

2x 16-bit basic timers

3x 16-bit advanced motor control timers

2x 32-bit timers

1x 16-bit LP timer

1x HR timer (D-Power) 12-channel w/ 184ps (A. delay line)

#### Analog

5x 12-bit ADC w/ HW overspl

7x Comparators

7x DAC (3x buff + 4x non-buff)

6x Op-Amp (PGA)

1x temperature sensor

Internal voltage reference

- 170MHz 32-bit Arm® Cortex®-M4 core with FPU
- Routine booster of CCM-SRAM up to 32 KB
- Mathematic hardware accelerators (CORDIC / FMAC)
- High-resolution timer (184 ps) for precise PWM control
- Rich advanced analog
- USB Type-C Power Delivery (PD)
- ±1% internal clock



#### MAIN APPLICATIONS













# Summary



### Summary

### Digital power ESS solution to power future microgrids



Technology of bidirectional power feature is a key to success for ESS applications

ST is ready to provide the solution and rich product portfolios for customers to focus on ESS product design

# Our technology starts with You



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